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#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

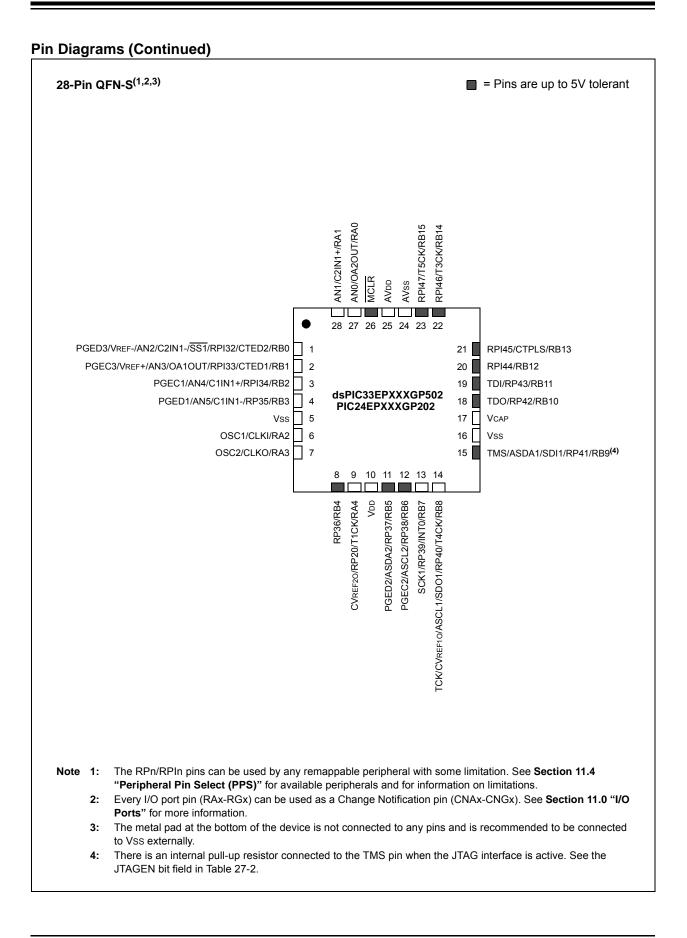
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Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	60 MIPs
Connectivity	CANbus, I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	53
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	
RAM Size	4K x 16
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 16x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep64gp506-e-pt

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X AND PIC24EPXXXGP/MC20X



### 3.8 Arithmetic Logic Unit (ALU)

The dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/ 50X and PIC24EPXXXGP/MC20X ALU is 16 bits wide, and is capable of addition, subtraction, bit shifts and logic operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. Depending on the operation, the ALU can affect the values of the Carry (C), Zero (Z), Negative (N), Overflow (OV) and Digit Carry (DC) Status bits in the <u>SR register. The C and DC</u> Status bits operate as Borrow and Digit Borrow bits, respectively, for subtraction operations.

The ALU can perform 8-bit or 16-bit operations, depending on the mode of the instruction that is used. Data for the ALU operation can come from the W register array or data memory, depending on the addressing mode of the instruction. Likewise, output data from the ALU can be written to the W register array or a data memory location.

Refer to the *"16-bit MCU and DSC Programmer's Reference Manual"* (DS70157) for information on the SR bits affected by each instruction.

The core CPU incorporates hardware support for both multiplication and division. This includes a dedicated hardware multiplier and support hardware for 16-bit divisor division.

#### 3.8.1 MULTIPLIER

Using the high-speed 17-bit x 17-bit multiplier, the ALU supports unsigned, signed, or mixed-sign operation in several MCU multiplication modes:

- 16-bit x 16-bit signed
- 16-bit x 16-bit unsigned
- 16-bit signed x 5-bit (literal) unsigned
- 16-bit signed x 16-bit unsigned
- 16-bit unsigned x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit signed
- 8-bit unsigned x 8-bit unsigned

### 3.8.2 DIVIDER

The divide block supports 32-bit/16-bit and 16-bit/16-bit signed and unsigned integer divide operations with the following data sizes:

- 32-bit signed/16-bit signed divide
- 32-bit unsigned/16-bit unsigned divide
- 16-bit signed/16-bit signed divide
- 16-bit unsigned/16-bit unsigned divide

The quotient for all divide instructions ends up in W0 and the remainder in W1. The 16-bit signed and unsigned DIV instructions can specify any W register for both the 16-bit divisor (Wn) and any W register (aligned) pair (W(m + 1):Wm) for the 32-bit dividend. The divide algorithm takes one cycle per bit of divisor, so both 32-bit/16-bit and 16-bit/16-bit instructions take the same number of cycles to execute.

## 3.9 DSP Engine (dsPIC33EPXXXMC20X/50X and dsPIC33EPXXXGP50X Devices Only)

The DSP engine consists of a high-speed 17-bit x 17-bit multiplier, a 40-bit barrel shifter and a 40-bit adder/subtracter (with two target accumulators, round and saturation logic).

The DSP engine can also perform inherent accumulatorto-accumulator operations that require no additional data. These instructions are ADD, SUB and NEG.

The DSP engine has options selected through bits in the CPU Core Control register (CORCON), as listed below:

- Fractional or integer DSP multiply (IF)
- · Signed, unsigned or mixed-sign DSP multiply (US)
- · Conventional or convergent rounding (RND)
- · Automatic saturation on/off for ACCA (SATA)
- Automatic saturation on/off for ACCB (SATB)
- Automatic saturation on/off for writes to data memory (SATDW)
- Accumulator Saturation mode selection (ACCSAT)

	SUMMARY	
Instruction	Algebraic Operation	ACC Write Back
CLR	A = 0	Yes
ED	$A = (x - y)^2$	No
EDAC	$A = A + (x - y)^2$	No
MAC	$A = A + (x \bullet y)$	Yes
MAC	$A = A + x^2$	No
MOVSAC	No change in A	Yes
MPY	$A = x \bullet y$	No
MPY	$A = x^2$	No
MPY.N	$A = -x \bullet y$	No
MSC	$A = A - x \bullet y$	Yes

TABLE 3-2: DSP INSTRUCTIONS SUMMARY

## 4.0 MEMORY ORGANIZATION

Note: This data sheet summarizes the features of the dsPIC33EPXXXGP50X, dsPIC33EPXXXGP/MC20X/50X and PIC24EPXXXGP/MC20X families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Program Memory" (DS70613) in the "dsPIC33/PIC24 Family Reference Manual', which is available from the Microchip web site (www.microchip.com).

The dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/ 50X and PIC24EPXXXGP/MC20X architecture features separate program and data memory spaces, and buses. This architecture also allows the direct access of program memory from the Data Space (DS) during code execution.

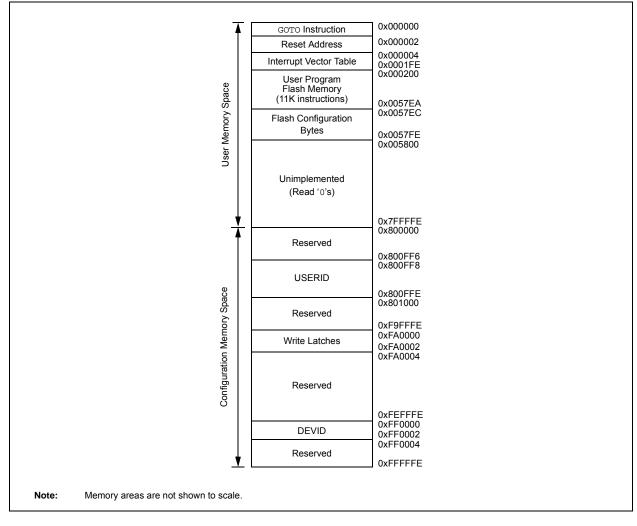
## 4.1 Program Address Space

The program address memory space of the dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X devices is 4M instructions. The space is addressable by a 24-bit value derived either from the 23-bit PC during program execution, or from table operation or Data Space remapping, as described in Section 4.8 "Interfacing Program and Data Memory Spaces".

User application access to the program memory space is restricted to the lower half of the address range (0x000000 to 0x7FFFF). The exception is the use of TBLRD operations, which use TBLPAG<7> to read Device ID sections of the configuration memory space.

The program memory maps, which are presented by device family and memory size, are shown in Figure 4-1 through Figure 4-5.

# FIGURE 4-1: PROGRAM MEMORY MAP FOR dsPIC33EP32GP50X, dsPIC33EP32MC20X/50X AND PIC24EP32GP/MC20X DEVICES



#### FIGURE 4-4: PROGRAM MEMORY MAP FOR dsPIC33EP256GP50X, dsPIC33EP256MC20X/50X AND PIC24EP256GP/MC20X DEVICES



Note: Memory areas are not shown to scale.

# **REGISTER 8-7:** DMAXPAD: DMA CHANNEL X PERIPHERAL ADDRESS REGISTER<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			PAD	<15:8>			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			PAE	)<7:0>			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplen	nented bit, read	d as '0'	
-n = Value at P	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown

#### bit 15-0 PAD<15:0>: Peripheral Address Register bits

**Note 1:** If the channel is enabled (i.e., active), writes to this register may result in unpredictable behavior of the DMA channel and should be avoided.

#### REGISTER 8-8: DMAXCNT: DMA CHANNEL X TRANSFER COUNT REGISTER<sup>(1)</sup>

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—				CNT<	13:8> <b>(2)</b>		
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			CNT<	<7:0> <b>(2)</b>			
bit 7							bit 0
Legend:							
R = Readable b	oit	W = Writable b	bit	U = Unimplen	nented bit, rea	id as '0'	
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown

bit 15-14 Unimplemented: Read as '0'

bit 13-0 CNT<13:0>: DMA Transfer Count Register bits<sup>(2)</sup>

**Note 1:** If the channel is enabled (i.e., active), writes to this register may result in unpredictable behavior of the DMA channel and should be avoided.

**2:** The number of DMA transfers = CNT<13:0> + 1.

# dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X AND PIC24EPXXXGP/MC20X

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0
bit 7							bit 0
Logondi							

#### REGISTER 9-4: OSCTUN: FRC OSCILLATOR TUNING REGISTER

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5-0 **TUN<5:0>:** FRC Oscillator Tuning bits 011111 = Maximum frequency deviation of 1.453% (7.477 MHz) 011110 = Center frequency + 1.406% (7.474 MHz) •••• 000001 = Center frequency + 0.047% (7.373 MHz) 000000 = Center frequency (7.37 MHz nominal) 111111 = Center frequency - 0.047% (7.367 MHz) ••• 100001 = Center frequency - 1.453% (7.263 MHz) 100000 = Minimum frequency deviation of -1.5% (7.259 MHz)

### REGISTER 11-15: RPINR37: PERIPHERAL PIN SELECT INPUT REGISTER 37 (dsPIC33EPXXXMC20X/50X AND PIC24EPXXXMC20X DEVICES ONLY)

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
				SYNCI1R<6:03	>		
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_			—			<u> </u>	_
bit 7							bit 0
Legend:							
R = Readab	ole bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'	
-n = Value a	it POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown
bit 15	Unimplemer	nted: Read as '	0'				
bit 15 bit 14-8	SYNCI1R<6:		M Synchroniz	zation Input 1 to nbers)	the Correspon	ding RPn Pin b	its
	SYNCI1R<6: (see Table 11	<b>0&gt;:</b> Assign PW	M Synchroniz selection nur		the Correspon	ding RPn Pin b	its
	SYNCI1R<6: (see Table 11	• <b>0&gt;:</b> Assign PWI I-2 for input pin	M Synchroniz selection nur		the Correspon	ding RPn Pin b	its
	SYNCI1R<6: (see Table 11	• <b>0&gt;:</b> Assign PWI I-2 for input pin	M Synchroniz selection nur		the Correspon	ding RPn Pin b	its
	SYNCI1R<6: (see Table 11 1111001 = I	• <b>0&gt;:</b> Assign PWI I-2 for input pin	M Synchroniz selection nur 121 P1		the Correspon	ding RPn Pin b	its

# 14.2 Input Capture Registers

#### REGISTER 14-1: ICxCON1: INPUT CAPTURE x CONTROL REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0		—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/HC/HS-0	R/HC/HS-0	R/W-0	R/W-0	R/W-0
—	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0
bit 7							bit 0

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable b	bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13	ICSIDL: Input Capture Stop in Idle Control bit
	1 = Input capture will Halt in CPU Idle mode
	0 = Input capture will continue to operate in CPU Idle mode
bit 12-10	ICTSEL<2:0>: Input Capture Timer Select bits
	111 = Peripheral clock (FP) is the clock source of the ICx
	110 = Reserved
	101 = Reserved
	100 = T1CLK is the clock source of the ICx (only the synchronous clock is supported) 011 = T5CLK is the clock source of the ICx
	010 = T4CLK is the clock source of the ICx
	001 = T2CLK is the clock source of the ICx
	000 = T3CLK is the clock source of the ICx
bit 9-7	Unimplemented: Read as '0'
bit 6-5	ICI<1:0>: Number of Captures per Interrupt Select bits (this field is not used if ICM<2:0> = 001 or 111)
	11 = Interrupt on every fourth capture event
	10 = Interrupt on every third capture event
	01 = Interrupt on every second capture event 00 = Interrupt on every capture event
bit 4	ICOV: Input Capture Overflow Status Flag bit (read-only)
bit 4	1 = Input capture buffer overflow occurred
	0 = No input capture buffer overflow occurred
bit 3	ICBNE: Input Capture Buffer Not Empty Status bit (read-only)
	1 = Input capture buffer is not empty, at least one more capture value can be read
	0 = Input capture buffer is empty
bit 2-0	ICM<2:0>: Input Capture Mode Select bits
	111 = Input capture functions as interrupt pin only in CPU Sleep and Idle modes (rising edge detect only, all other control bits are not applicable)
	110 = Unused (module is disabled)
	101 = Capture mode, every 16th rising edge (Prescaler Capture mode)
	<ul> <li>100 = Capture mode, every 4th rising edge (Prescaler Capture mode)</li> <li>011 = Capture mode, every rising edge (Simple Capture mode)</li> </ul>
	010 = Capture mode, every falling edge (Simple Capture mode)
	001 = Capture mode, every edge rising and falling (Edge Detect mode (ICI<1:0>) is not used in this mode)
	000 = Input capture module is turned off

### 15.1 Output Compare Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

Note:	In the event you are not able to access the product page using the link above, enter this URL in your browser:
	http://www.microchip.com/wwwproducts/ Devices.aspx?dDocName=en555464

#### 15.1.1 KEY RESOURCES

- "Output Compare" (DS70358) in the "dsPIC33/ PIC24 Family Reference Manual"
- · Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related "dsPIC33/PIC24 Family Reference Manual" Sections
- Development Tools

#### REGISTER 16-1: PTCON: PWMx TIME BASE CONTROL REGISTER (CONTINUED)

bit 6-4	SYNCSRC<2:0>: Synchronous Source Selection bits <sup>(1)</sup> 111 = Reserved 100 = Reserved
bit 3-0	100 = Reserved 011 = PTGO17 <sup>(2)</sup> 010 = PTGO16 <sup>(2)</sup> 001 = Reserved 000 = SYNCI1 input from PPS SEVTPS<3:0>: PWMx Special Event Trigger Output Postscaler Select bits <sup>(1)</sup>
	<ul> <li>1111 = 1:16 Postscaler generates Special Event Trigger on every sixteenth compare match event</li> <li>.</li> <l< td=""></l<></ul>
	0000 = 1:1 Postscaler generates Special Event Trigger on every second compare match event

- **Note 1:** These bits should be changed only when PTEN = 0. In addition, when using the SYNCI1 feature, the user application must program the period register with a value that is slightly larger than the expected period of the external synchronization input signal.
  - 2: See Section 24.0 "Peripheral Trigger Generator (PTG) Module" for information on this selection.

#### REGISTER 16-7: PWMCONx: PWMx CONTROL REGISTER (CONTINUED)

bit 7-	6	DTC<1:0>: Dead-Time Control bits
		11 = Dead-Time Compensation mode
		10 = Dead-time function is disabled
		01 = Negative dead time is actively applied for Complementary Output mode
		00 = Positive dead time is actively applied for all output modes
bit 5		<b>DTCP:</b> Dead-Time Compensation Polarity bit <sup>(3)</sup>
		When Set to '1':
		If DTCMPx = 0, PWMxL is shortened and PWMxH is lengthened. If DTCMPx = 1, PWMxH is shortened and PWMxL is lengthened.
		When Set to '0':
		If $DTCMPx = 0$ , $PWMxH$ is shortened and $PWMxL$ is lengthened.
		If DTCMPx = 1, PWMxL is shortened and PWMxH is lengthened.
bit 4		Unimplemented: Read as '0'
bit 3		MTBS: Master Time Base Select bit
		<ul> <li>1 = PWM generator uses the secondary master time base for synchronization and as the clock source for the PWM generation logic (if secondary time base is available)</li> </ul>
		0 = PWM generator uses the primary master time base for synchronization and as the clock source for the PWM generation logic
bit 2		<b>CAM:</b> Center-Aligned Mode Enable bit <sup>(2,4)</sup>
		1 = Center-Aligned mode is enabled
		0 = Edge-Aligned mode is enabled
bit 1		XPRES: External PWMx Reset Control bit <sup>(5)</sup>
		<ul> <li>1 = Current-limit source resets the time base for this PWM generator if it is in Independent Time Base mode</li> </ul>
		0 = External pins do not affect PWMx time base
bit 0		IUE: Immediate Update Enable bit <sup>(2)</sup>
		1 = Updates to the active MDC/PDCx/DTRx/ALTDTRx/PHASEx registers are immediate
		<ul> <li>Updates to the active MDC/PDCx/DTRx/ALTDTRx/PHASEx registers are synchronized to the PWMx period boundary</li> </ul>
Note	1:	Software must clear the interrupt status here and in the corresponding IFSx bit in the interrupt controller.
	2:	These bits should not be changed after the PWMx is enabled (PTEN = 1).
	3:	DTC<1:0> = 11 for DTCP to be effective; otherwise, DTCP is ignored.
	4:	The Independent Time Base (ITB = 1) mode must be enabled to use Center-Aligned mode. If ITB = 0, the CAM bit is ignored.

**5:** To operate in External Period Reset mode, the ITB bit must be '1' and the CLMOD bit in the FCLCONx register must be '0'.

# REGISTER 19-1: I2CxCON: I2Cx CONTROL REGISTER (CONTINUED)

etching etching
rating as I <sup>2</sup> C master, applicable during master receive)
e initiates an Acknowledge sequence.
bit during master receive)
DAx and SCLx pins and transmits ACKDT data bit. Hardware owledge sequence. ress
g as I <sup>2</sup> C master)
are is clear at the end of the eighth bit of the master receive
erating as I <sup>2</sup> C master)
SCLx pins. Hardware is clear at the end of the master Stop
$\frac{1}{2}$
it (when operating as I <sup>2</sup> C master)
SDAx and SCLx pins. Hardware is clear at the end of the gress
erating as I <sup>2</sup> C master)
SCLx pins. Hardware is clear at the end of the master Start

**Note 1:** When performing master operations, ensure that the IPMIEN bit is set to '0'.

## 21.2 Modes of Operation

The ECAN module can operate in one of several operation modes selected by the user. These modes include:

- · Initialization mode
- Disable mode
- Normal Operation mode
- · Listen Only mode
- Listen All Messages mode
- Loopback mode

Modes are requested by setting the REQOP<2:0> bits (CxCTRL1<10:8>). Entry into a mode is Acknowledged by monitoring the OPMODE<2:0> bits (CxCTRL1<7:5>). The module does not change the mode and the OPMODEx bits until a change in mode is acceptable, generally during bus Idle time, which is defined as at least 11 consecutive recessive bits.

#### 21.3 ECAN Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

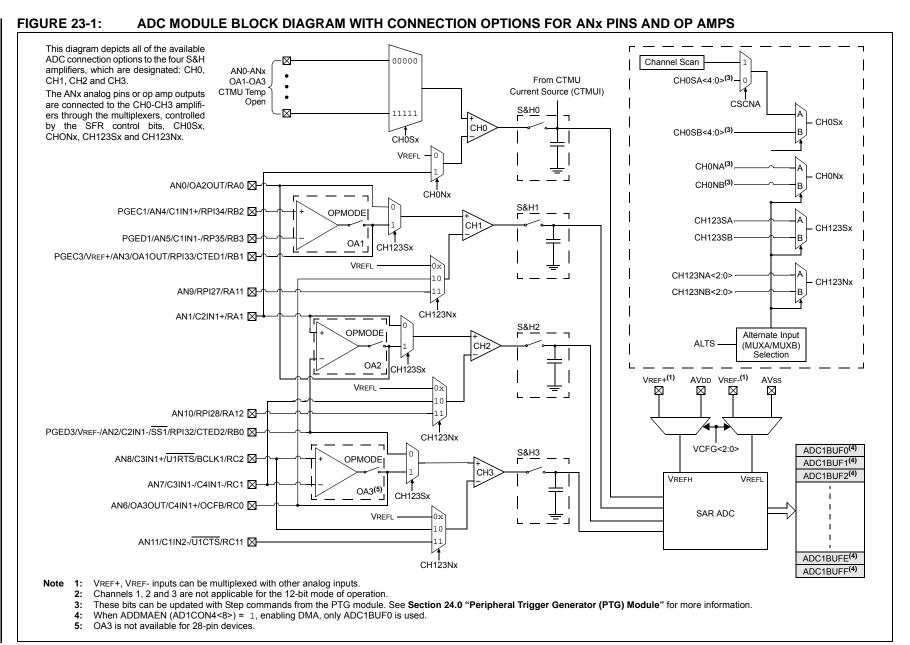
Note:	In the event you are not able to access the
	product page using the link above, enter
	this URL in your browser:
	http://www.microchip.com/wwwproducts/
	Devices.aspx?dDocName=en555464

#### 21.3.1 KEY RESOURCES

- "Enhanced Controller Area Network (ECAN™)" (DS70353) in the "dsPIC33/PIC24 Family Reference Manual"
- · Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related *"dsPIC33/PIC24 Family Reference Manual"* Sections
- · Development Tools

U-0	U-0	U-0	R-0	R-0	R-0	R-0	R-0		
_	_		FILHIT4	FILHIT3	FILHIT2	FILHIT1	FILHIT0		
bit 15	<b>I</b>						bit 8		
U-0	R-1	R-0	R-0	R-0	R-0	R-0	R-0		
_	ICODE6	ICODE5	ICODE4	ICODE3	ICODE2	ICODE1	ICODE0		
bit 7							bit		
Logondi									
Legend: R = Readable	- hit		hit	LI – Unimplor	mented bit, rea	d as '0'			
-n = Value at				'0' = Bit is cle		x = Bit is unkr			
	FUR	'1' = Bit is set				x – Dit is uliki			
bit 15-13	Unimplemen	ted: Read as '	0'						
bit 12-8	=	Filter Hit Num							
		1 = Reserved							
	01111 <b>= Filte</b>	er 15							
	•								
	•								
	•								
	00001 = Filte 00000 = Filte								
bit 7		ted: Read as '	0'						
bit 6-0	ICODE<6:0>: Interrupt Flag Code bits								
	1000101-1111111 = Reserved								
		IFO almost full							
		leceiver overflo							
	1000010 = K 1000001 = E	Vake-up interru rror interrupt	μ						
	1000000 = N								
	•								
	•								
	•								
		11111 = Rese							
	•	B15 buffer inte	inupt						
	•								
	•								
	0001001 <b>= R</b>	B9 buffer inter	rupt						
		B8 buffer inter							
		RB7 buffer inte RB6 buffer inte							
	0000101 = TRB5 buffer interrupt 0000100 = TRB4 buffer interrupt								
	0000011 <b>= T</b>	RB3 buffer inte	errupt						
		RB2 buffer inte RB1 buffer inte							

## REGISTER 21-3: CxVEC: ECANx INTERRUPT CODE REGISTER



dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X AND PIC24EPXXXGP/MC20X

# **REGISTER 24-3: PTGBTE: PTG BROADCAST TRIGGER ENABLE REGISTER**<sup>(1,2)</sup> (CONTINUED)

bit 4	OC1CS: Clock Source for OC1 bit
	<ul> <li>1 = Generates clock pulse when the broadcast command is executed</li> <li>0 = Does not generate clock pulse when the broadcast command is executed</li> </ul>
bit 3	OC4TSS: Trigger/Synchronization Source for OC4 bit
	<ul> <li>1 = Generates Trigger/Synchronization when the broadcast command is executed</li> <li>0 = Does not generate Trigger/Synchronization when the broadcast command is executed</li> </ul>
bit 2	OC3TSS: Trigger/Synchronization Source for OC3 bit
	<ul> <li>1 = Generates Trigger/Synchronization when the broadcast command is executed</li> <li>0 = Does not generate Trigger/Synchronization when the broadcast command is executed</li> </ul>
bit 1	OC2TSS: Trigger/Synchronization Source for OC2 bit
	<ul> <li>1 = Generates Trigger/Synchronization when the broadcast command is executed</li> <li>0 = Does not generate Trigger/Synchronization when the broadcast command is executed</li> </ul>
bit 0	OC1TSS: Trigger/Synchronization Source for OC1 bit
	<ul> <li>1 = Generates Trigger/Synchronization when the broadcast command is executed</li> <li>0 = Does not generate Trigger/Synchronization when the broadcast command is executed</li> </ul>

- **Note 1:** This register is read-only when the PTG module is executing Step commands (PTGEN = 1 and PTGSTRT = 1).
  - 2: This register is only used with the PTGCTRL OPTION = 1111 Step command.

#### 25.1.2 OP AMP CONFIGURATION B

Figure 25-7 shows a typical inverting amplifier circuit with the output of the op amp (OAxOUT) externally routed to a separate analog input pin (ANy) on the device. This op amp configuration is slightly different in terms of the op amp output and the ADC input connection, therefore, RINT1 is not included in the transfer function. However, this configuration requires the designer to externally route the op amp output (OAxOUT) to another analog input pin (ANy). See Table 30-53 in **Section 30.0 "Electrical Characteristics"** for the typical value of RINT1. Table 30-60 and Table 30-61 in **Section 30.0 "Electrical Characteristics"** describe the minimum sample time (TSAMP) requirements for the ADC module in this configuration.

Figure 25-7 also defines the equation to be used to calculate the expected voltage at point VOAxOUT. This is the typical inverting amplifier equation.

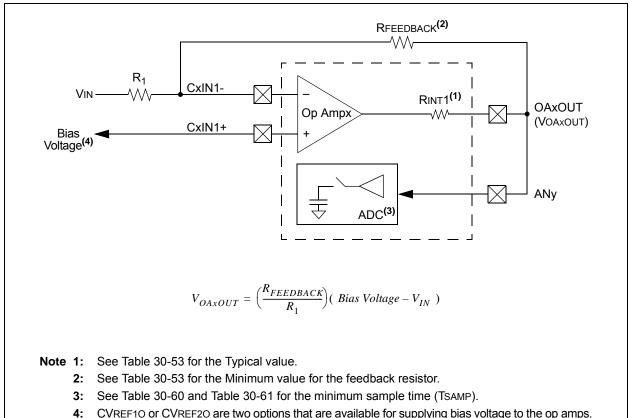
## 25.2 Op Amp/Comparator Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

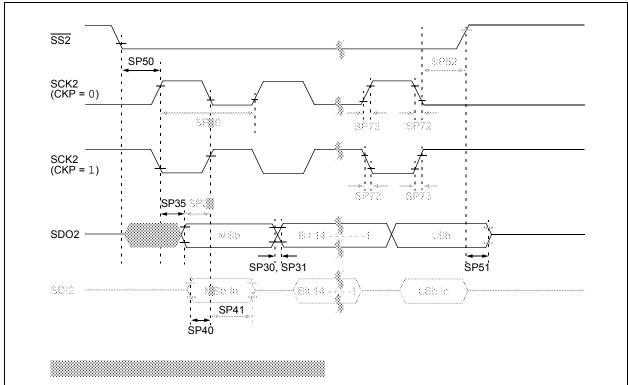
Note:	In the event you are not able to access the
	product page using the link above, enter
	this URL in your browser:
	http://www.microchip.com/wwwproducts/
	Devices.aspx?dDocName=en555464

#### 25.2.1 KEY RESOURCES

- "Op Amp/Comparator" (DS70357) in the "dsPIC33/PIC24 Family Reference Manual"
- Code Samples
- · Application Notes
- Software Libraries
- · Webinars
- All Related "dsPIC33/PIC24 Family Reference Manual" Sections
- Development Tools

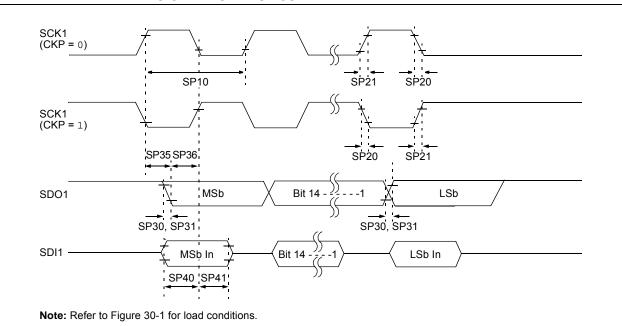


#### FIGURE 25-7: OP AMP CONFIGURATION B



#### FIGURE 30-21: SPI2 SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0) TIMING CHARACTERISTICS





# TABLE 30-44:SPI1 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1)TIMING REQUIREMENTS

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 3.0V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +125^{\circ}C \mbox{ for Extended} \end{array}$				
Param.	Symbol	Characteristic <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units	Conditions
SP10	FscP	Maximum SCK1 Frequency		—	10	MHz	-40°C to +125°C (Note 3)
SP20	TscF	SCK1 Output Fall Time	_	—	_	ns	See Parameter DO32 (Note 4)
SP21	TscR	SCK1 Output Rise Time	_	—	_	ns	See Parameter DO31 (Note 4)
SP30	TdoF	SDO1 Data Output Fall Time	_	—	_	ns	See Parameter DO32 (Note 4)
SP31	TdoR	SDO1 Data Output Rise Time	_	—	_	ns	See Parameter DO31 (Note 4)
SP35	TscH2doV, TscL2doV	SDO1 Data Output Valid after SCK1 Edge	_	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO1 Data Output Setup to First SCK1 Edge	30	—	_	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI1 Data Input to SCK1 Edge	30	—	_	ns	
SP41	TscH2diL, TscL2diL	Hold Time of SDI1 Data Input to SCK1 Edge	30	—	—	ns	

**Note 1:** These parameters are characterized, but are not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated.

- **3:** The minimum clock period for SCK1 is 100 ns. The clock generated in Master mode must not violate this specification.
- 4: Assumes 50 pF load on all SPI1 pins.

Section Name	Update Description			
Section 16.0 "High-Speed PWM Module (dsPIC33EPXXXMC20X/50X and PIC24EPXXXMC20X Devices Only)"	Figure 16-2).			
Section 21.0 "Enhanced CAN (ECAN™) Module (dsPIC33EPXXXGP/MC50X Devices Only)"	Updated the CANCKS bit value definitions in CiCTRL1: ECAN Control Register 1 (see Register 21-1).			
Section 22.0 "Charge Time Measurement Unit (CTMU)"	Updated the IRNG<1:0> bit value definitions and added Note 2 in the CTMU Current Control Register (see Register 22-3).			
Section 25.0 "Op amp/ Comparator Module"	Updated the Op amp/Comparator I/O Operating Modes Diagram (see Figure 25-1). Updated the User-programmable Blanking Function Block Diagram (see Figure 25-3). Updated the Digital Filter Interconnect Block Diagram (see Figure 25-4). Added <b>Section 25.1 "Op amp Application Considerations</b> ". Added Note 2 to the Comparator Control Register (see Register 25-2). Updated the bit definitions in the Comparator Mask Gating Control Register (see Register 25-5).			
Section 27.0 "Special Features"	Updated the FICD Configuration Register, updated Note 1, and added Note 3 in the Configuration Byte Register Map (see Table 27-1). Added <b>Section 27.2 "User ID Words"</b> .			
Section 30.0 "Electrical Characteristics"	<ul> <li>Updated the following Absolute Maximum Ratings:</li> <li>Maximum current out of Vss pin</li> <li>Maximum current into VDD pin</li> <li>Added Note 1 to the Operating MIPS vs. Voltage (see Table 30-1).</li> </ul>			
	Updated all Idle Current (IIDLE) Typical and Maximum DC Characteristics values (see Table 30-7).			
	Updated all Doze Current (IDOZE) Typical and Maximum DC Characteristics values (see Table 30-9).			
	Added Note 2, removed Parameter CM24, updated the Typical values Parameters CM10, CM20, CM21, CM32, CM41, CM44, and CM45, and updated the Minimum values for CM40 and CM41, and the Maximum value for CM40 in the AC/DC Characteristics: Op amp/Comparator (see Table 30-14).			
	Updated Note 2 and the Typical value for Parameter VR310 in the Op amp/ Comparator Reference Voltage Settling Time Specifications (see Table 30-15).			
	Added Note 1, removed Parameter VRD312, and added Parameter VRD314 to the Op amp/Comparator Voltage Reference DC Specifications (see Table 30-16).			
	Updated the Minimum, Typical, and Maximum values for Internal LPRC Accuracy (see Table 30-22).			
	Updated the Minimum, Typical, and Maximum values for Parameter SY37 in the Reset, Watchdog Timer, Oscillator Start-up Timer, Power-up Timer Timing Requirements (see Table 30-24).			
	The Maximum Data Rate values were updated for the SPI2 Maximum Data/Clock Rate Summary (see Table 30-35)			

## TABLE A-2: MAJOR SECTION UPDATES (CONTINUED)